

## **AMENDMENTS TO THE CLAIMS**

**This listing of claims will replace all prior versions and listings of claims in the application:**

### **LISTING OF CLAIMS:**

1. (currently amended): A magnetic head comprising a film comprised of diamond-like carbon (hereinafter, referred to as “diamond-like carbon film”) between a substrate and an insulating layer, wherein

said film has a Vickers hardness equal to or greater than  $2000 \text{ kg/mm}^2$ ; ~~and~~

the diamond-like carbon film is provided directly on the substrate; and

the diamond-like carbon film, the insulating layer, a lower shield layer, a lower gap layer, a magnetoresistive element, an upper gap layer, an upper shield layer, and a protective layer are provided in this order on one side surface of the substrate.

2. (canceled).

3. (original): The magnetic head according to claim 1, wherein said film has a thickness equal to or greater than 100 nm.

4. (original): The magnetic head according to claim 1, wherein said magnetic head is a magnetoresistive head.

5. (canceled).

6. (currently amended): The magnetic head according to ~~claim 5~~ claim 1, wherein said substrate is comprised of a nonmagnetic material.

7. (original): The magnetic head according to claim 6, wherein said nonmagnetic material is AlTiC ( $\text{Al}_2\text{O}_3 \cdot \text{TiC}$ ),  $\alpha$ - $\text{Fe}_2\text{O}_3$  ( $\alpha$ -hematite), NiO-TiO<sub>2</sub>-MgO, TiO<sub>2</sub>-CaO, or NiO-MnO.

8. (currently amended): The magnetic head according to ~~claim 5~~ claim 1, wherein said substrate is comprised of a magnetic material.

9. (original): The magnetic head according to claim 8, wherein said magnetic material is Ni-Zn ferrite or Mn-Zn ferrite.

10. (currently amended): The magnetic head according to ~~claim 5~~ claim 1, wherein said magnetoresistive element is a magnetoresistive element comprising a lower layer in the form of a tantalum layer, a SAL bias layer in the form of a NiFeNb layer, an intermediate insulating layer in the form of a tantalum layer, a magnetoresistive layer in the form of a NiFe layer, and an upper layer in the form of a tantalum layer in this order.

11. (currently amended): The magnetic head according to ~~claim 5~~ claim 1, wherein said substrate has a thickness ranging from 60 to 100  $\mu\text{m}$ .

12. (currently amended): The magnetic head according to ~~claim 5~~ claim 1, wherein said insulating layer has a thickness ranging from 15 to 30  $\mu\text{m}$ .

13. (currently amended): The magnetic head according to ~~claim 5~~ claim 1, wherein said lower shield layer has a thickness ranging from 2 to 4  $\mu\text{m}$ .

14. (currently amended): The magnetic head according to ~~claim 5~~ claim 1, wherein said upper shield layer has a thickness ranging from 2 to 4  $\mu\text{m}$ .

15. (currently amended): The magnetic head according to ~~claim 5~~ claim 1, wherein said lower gap layer has a thickness ranging from 60 to 140 nm.

16. (currently amended): The magnetic head according to ~~claim 5~~ claim 1, wherein said upper gap layer has a thickness ranging from 80 to 160 nm.

17. (currently amended): The magnetic head according to ~~claim 5~~ claim 1, wherein said protective layer has a thickness ranging from 2 to 6  $\mu\text{m}$ .

18. (currently amended): The magnetic head according to claim 4, wherein the substrate is ~~comprised of~~ comprises a nonmagnetic material, and ~~the diamond-like carbon film, the insulating layer comprised of~~ comprises an insulating material,

~~a lower shield layer comprised of~~ the lower shield layer comprises a magnetic material,  
~~a lower gap layer comprised of~~ the lower gap layer comprises a nonmagnetic material, a  
magnetoresistive element,  
~~an upper gap layer comprised of~~ the upper gap layer comprises a nonmagnetic material,  
~~an upper shield layer comprised of~~ the upper shield layer comprises a magnetic material,  
and  
~~a protective layer comprised of~~ the protective layer comprises an insulating material are  
provided in this order on one side surface of the substrate.

19. (original): The magnetic head according to claim 18, wherein said substrate is comprised of AlTiC ( $\text{Al}_2\text{O}_3 \cdot \text{TiC}$ ),  $\alpha$ - $\text{Fe}_2\text{O}_3$  ( $\alpha$ -hematite), NiO-TiO<sub>2</sub>-MgO, TiO<sub>2</sub>-CaO, or NiO-MnO.

20. (original): The magnetic head according to claim 18, wherein said insulating layer is comprised of alumina ( $\text{Al}_2\text{O}_3$ ), silica ( $\text{SiO}_2$ ), AlN, Al-N-X (where X denotes one or more of Si, B, Cr, Ti, Ta and Nb), SiN, SiC, DLC, BN, MgO, SiAlON, AlON, Si<sub>3</sub>Na, SiCO, SiON, or SiCON.

21. (original): The magnetic head according to claim 18, wherein said lower shield layer and said upper lower shield layer are respectively comprised of Fe-Si-Al alloy (Sendust), Ni-Fe alloy (Permalloy), or Ni-Zn alloy (hematite).

22. (original): The magnetic head according to claim 18, wherein said lower gap layer and said upper gap layer are respectively comprised of alumina ( $\text{Al}_2\text{O}_3$ ) or silica ( $\text{SiO}_2$ ).

23. (original): The magnetic head according to claim 18, wherein said magnetoresistive element is a magnetoresistive element comprising a lower layer in the form of a tantalum layer, a SAL bias layer in the form of a NiFeNb layer, an intermediate insulating layer in the form of a tantalum layer, a magnetoresistive layer in the form of a NiFe layer, and an upper layer in the form of a tantalum layer in this order.

24. (original): The magnetic head according to claim 18, wherein said protective layer is comprised of alumina ( $\text{Al}_2\text{O}_3$ ) or silica ( $\text{SiO}_2$ ).

25. (original): The magnetic head according to claim 18, wherein said substrate has a thickness ranging from 60 to 100  $\mu\text{m}$ .

26. (original): The magnetic head according to claim 18, wherein said insulating layer has a thickness ranging from 15 to 30  $\mu\text{m}$ .

27. (original): The magnetic head according to claim 18, wherein said lower shield layer has a thickness ranging from 2 to 4  $\mu\text{m}$ .

28. (original): The magnetic head according to claim 18, wherein said upper shield layer has a thickness ranging from 2 to 4  $\mu$  m.

29. (original): The magnetic head according to claim 18, wherein said lower gap layer has a thickness ranging from 60 to 140 nm.

30. (original): The magnetic head according to claim 18, wherein said upper gap layer has a thickness ranging from 80 to 160 nm.

31. (original): The magnetic head according to claim 18, wherein said protective layer has a thickness ranging from 2 to 6  $\mu$  m.